



Shantou Huashan Electronic Devices Co.,Ltd.

N-Channel MOSFET

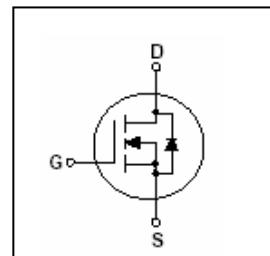
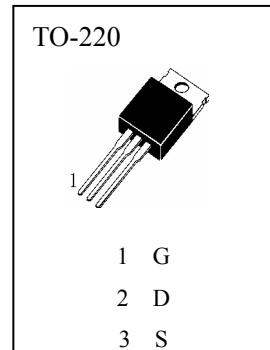
**HFP75N08**

## APPLICATIONS

Low Voltage high-Speed Switching.

## ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ C$ )

$T_{stg}$ —— Storage Temperature .....	-55~175
$T_j$ —— Operating Junction Temperature .....	150
$P_D$ —— Allowable Power Dissipation( $T_c=25^\circ C$ ) .....	173W
$V_{DSS}$ —— Drain-Source Voltage .....	80V
$V_{GSS}$ —— Gate-Source Voltage .....	$\pm 20V$
$I_D$ —— Drain Current( $T_c=25^\circ C$ ) .....	75A



## ELECTRICAL CHARACTERISTICS ( $T_a=25^\circ C$ )

Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
$BV_{DSS}$	Drain-Source Breakdown Voltage	80			V	$I_D=250 \mu A, V_{GS}=0V$
$I_{DSS}$	Zero Gate Voltage Drain Current			10	$\mu A$	$V_{DS} = 80V, V_{GS}=0$
$I_{GSS}$	Gate –Source Leakage Current			$\pm 100$	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
$R_{DS(on)}$	Static Drain-Source On-Resistance	0.011	0.014		$\Omega$	$V_{GS}=10V, I_D = 37.5A$
$C_{iss}$	Input Capacitance	2600	3380		pF	$V_{DS} = 25V, V_{GS}=0, f=1MHz$
$C_{oss}$	Output Capacitance	940	1220		pF	
$C_{rss}$	Reverse Transfer Capacitance	210	275		pF	
$t_{d(on)}$	Turn - On Delay Time	30	70		nS	$V_{DD} = 40V, I_D = 75A$ $R_G = 25 \Omega$ *
$t_r$	Rise Time	225	460		nS	
$t_{d(off)}$	Turn - Off Delay Time	165	340		nS	
$t_f$	Fall Time	155	320		nS	$V_{DS} = 48V$ $V_{GS}=10V$ $I_D=50A^*$
$Q_g$	Total Gate Charge	80	105		nC	
$Q_{gs}$	Gate–Source Charge	15			nC	
$Q_{gd}$	Gate–Drain Charge	32			nC	$I_S = 75A, V_{GS}=0$
$I_s$	Continuous Source Current			75	A	
$V_{SD}$	Diode Forward Voltage			1.5	V	
$R_{th(j-c)}$	Thermal Resistance , Junction-to-Case			0.87	/W	

\*Pulse Test : Pulse Width 300  $\mu s$ , Duty Cycle 2%



Shantou Huashan Electronic Devices Co.,Ltd.

N-Channel MOSFET

**HFP75N08**

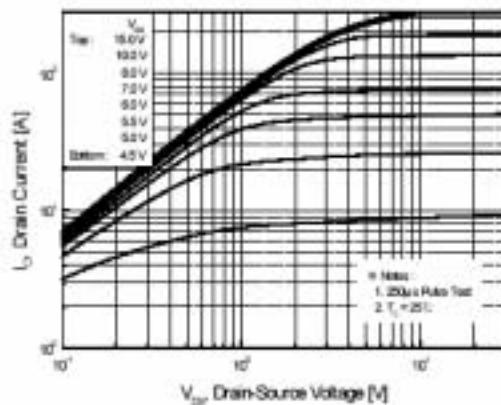


Figure 1. On-Region Characteristics

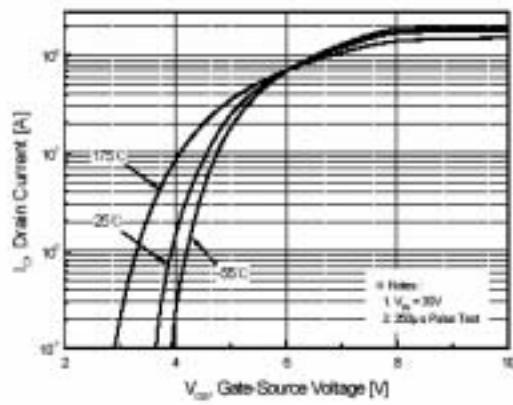


Figure 2. Transfer Characteristics

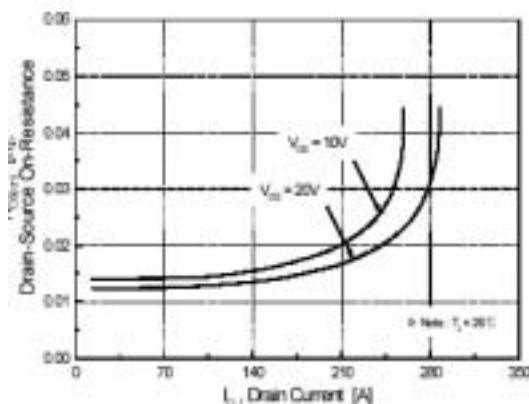


Figure 3. On-Resistance Variation vs.  
Drain Current and Gate Voltage

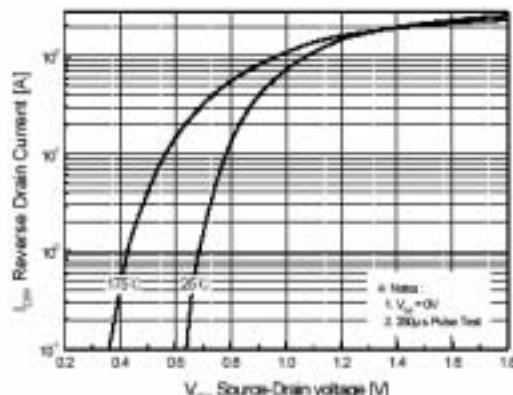


Figure 4. Body Diode Forward Voltage  
Variation vs. Source Current

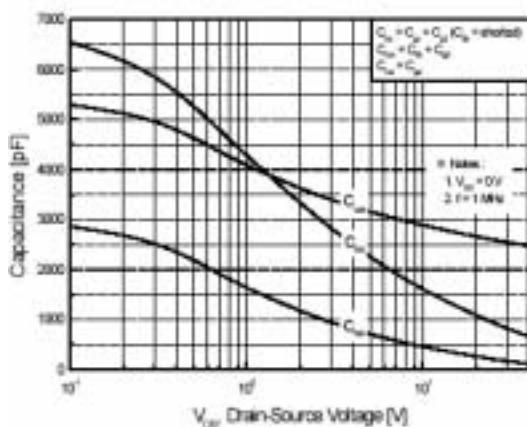


Figure 5. Capacitance Characteristics

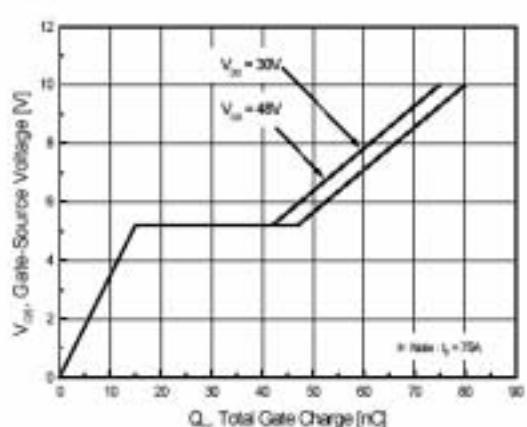


Figure 6. Gate Charge Characteristics



Shantou Huashan Electronic Devices Co.,Ltd.

N-Channel MOSFET

# HFP75N08

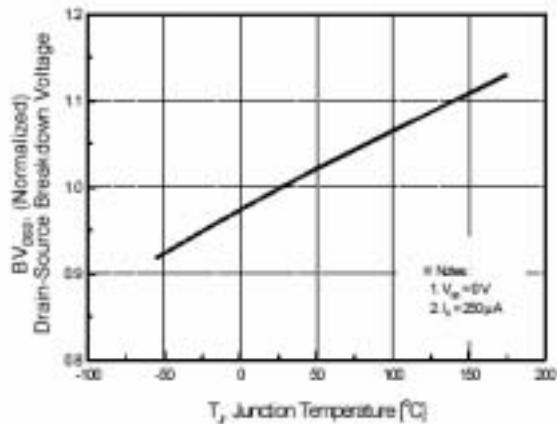


Figure 7. Breakdown Voltage Variation  
vs. Temperature

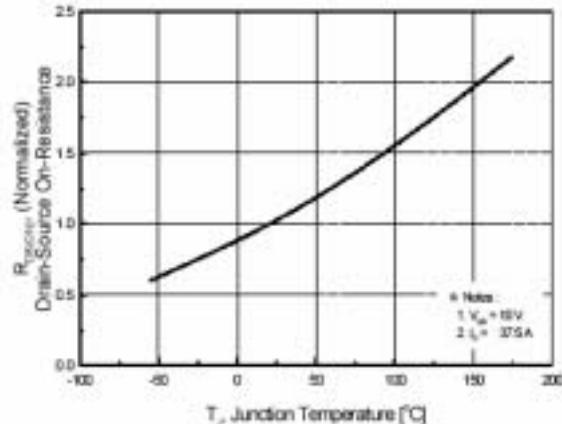


Figure 8. On-Resistance Variation  
vs. Temperature

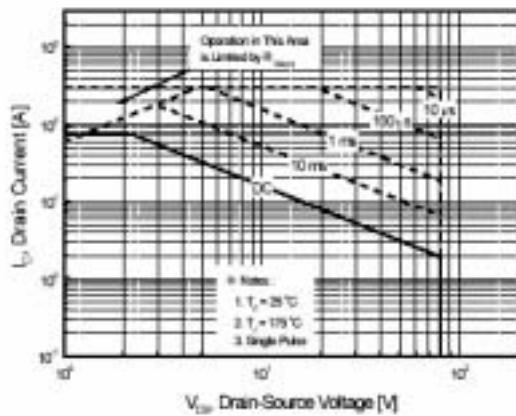


Figure 9. Maximum Safe Operating Area

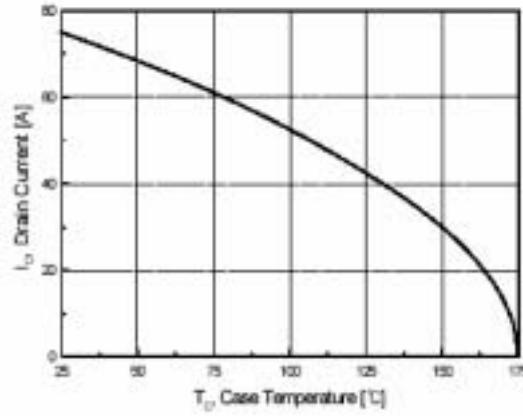


Figure 10. Maximum Drain Current  
vs. Case Temperature

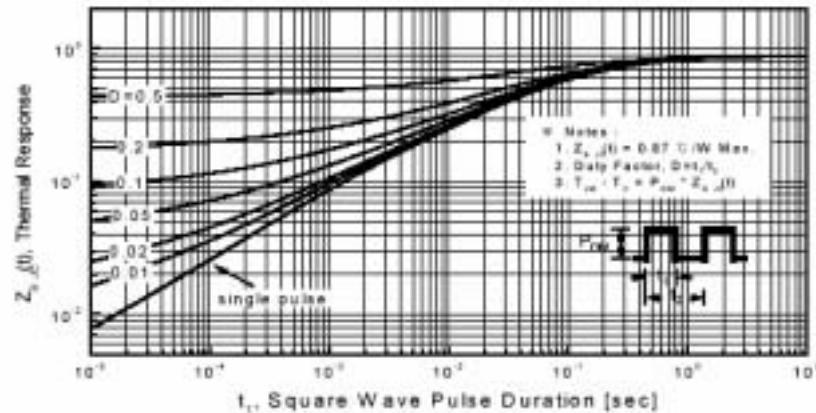


Figure 11. Transient Thermal Response Curve

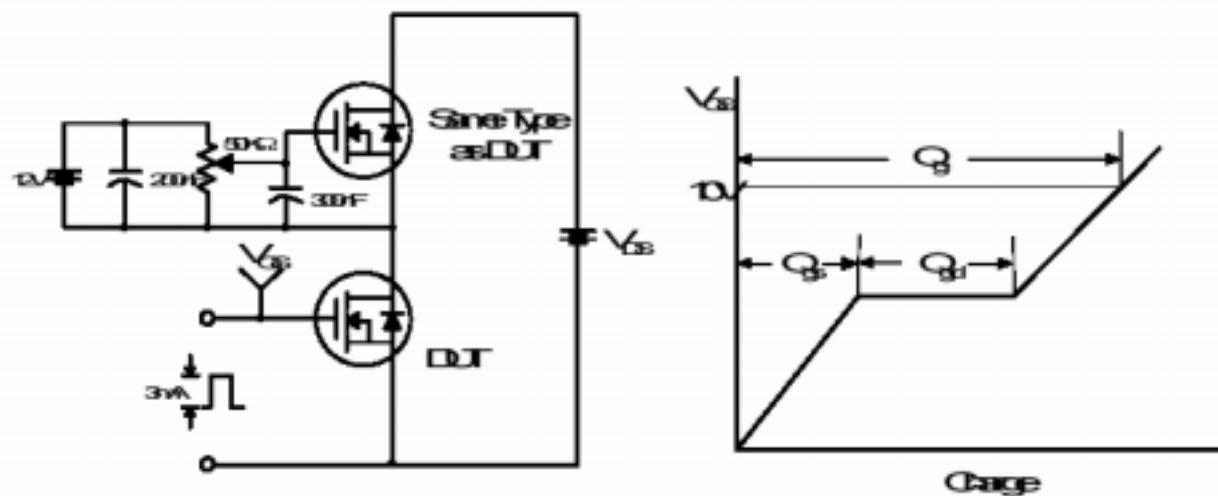


Shantou Huashan Electronic Devices Co.,Ltd.

N-Channel MOSFET

**HFP75N08**

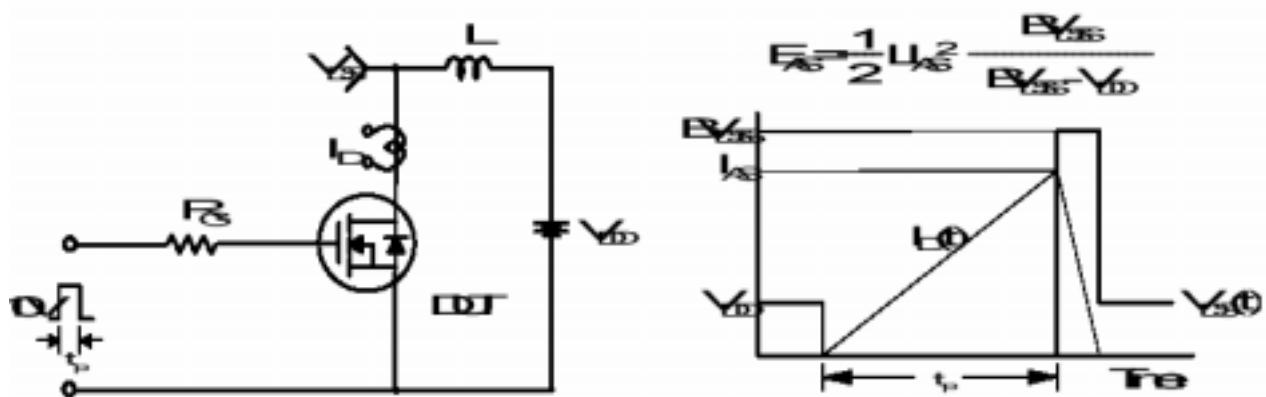
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms





Shantou Huashan Electronic Devices Co.,Ltd.

N-Channel MOSFET

**HFP75N08**

Peak Diode Recovery dv/dt Test Circuit & Waveforms

